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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In regard to the Patent Application of Jiang-Jen Lin and Yi-Chien Chen:

Application No.: 10/039,558

Filing Date: January 8, 2002

Publication No.: US 2003/0134957A1

Publication Date: July 17, 2003

For: COMPLEXES OF CLAY AND POLYOXYALKYLENE AMINE AND METHOD
FOR PRODUCING THE SAME.

Commissioner for Patents
Washington, DC 20231

Dear Sir/Madame:

Pursuant to 37 C.F.R. §1.99, the undersigned hereby submits copies of the following publication relevant to the subject published application:

1. US 6,096,803 (Aug. 1, 2000)
Methods of Preparation of Organic-Inorganic Hybrid Nanocomposites.
2. US 6,017,632 (Jan. 25, 2000)
Hybrid Organic-Inorganic Nanocomposites and Methods of Preparation.
3. US 5,993,769 (Nov. 30, 1999)
Homostructured Mixed Organic and Inorganic Cation Exchanged Tapered Compositions.
4. US 5,866,645 (Feb. 2, 1999)
Homostructured Mixed Organic and Inorganic Cation Exchanged Tapered Compositions.
5. US 5,853,886 (Dec. 29, 1998)
Hybrid Nanocomposites Comprising Layered Inorganic Material and Methods of Preparation.
6. US 5,801,216 (Sept. 1, 1998)
Flexible Resin-Clay Composite, Method of Preparation and Use.
7. US 5,760,106 (June 2, 1998)
Sealant Method of Epoxy Resin-Clay Composites.

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Entry of these documents into the application file is respectfully requested.

A check in the amount of \$180.00, the requisite fee for filing paper, is enclosed.

A copy of the submission is being served upon the attorney for the applicants in accordance with 37C.F.R. 1§.248.

Respectfully submitted,

Dated: August 14, 2003

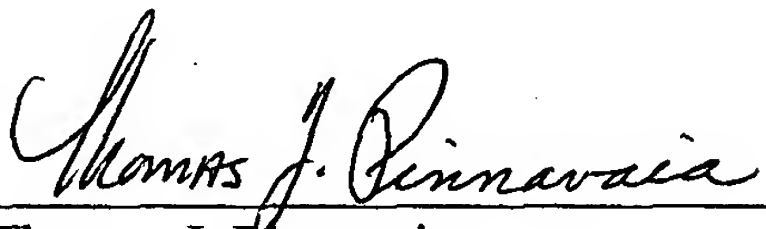
By Thomas J. Pinnavaia
Thomas J. Pinnavaia
Claytec, Inc



CERTIFICATE OF SERVICE

I hereby certify that a copy of the foregoing Third-Party Submission in Published Application has been served upon the attorney by first-class mail, postage prepaid, this 14th Day of August, 2003, addressed as follows:

Charles E. Baxley
Hart, Baxley, Daniels and Holton
Fifth Floor
59 John St.
New York, NY 10038 (US)



Thomas J. Pinnavaia
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